

DB151-DB157 SINGLE PHASE 1.0AMP GLASS PASSIVATED BRIDGE RECTIFIER

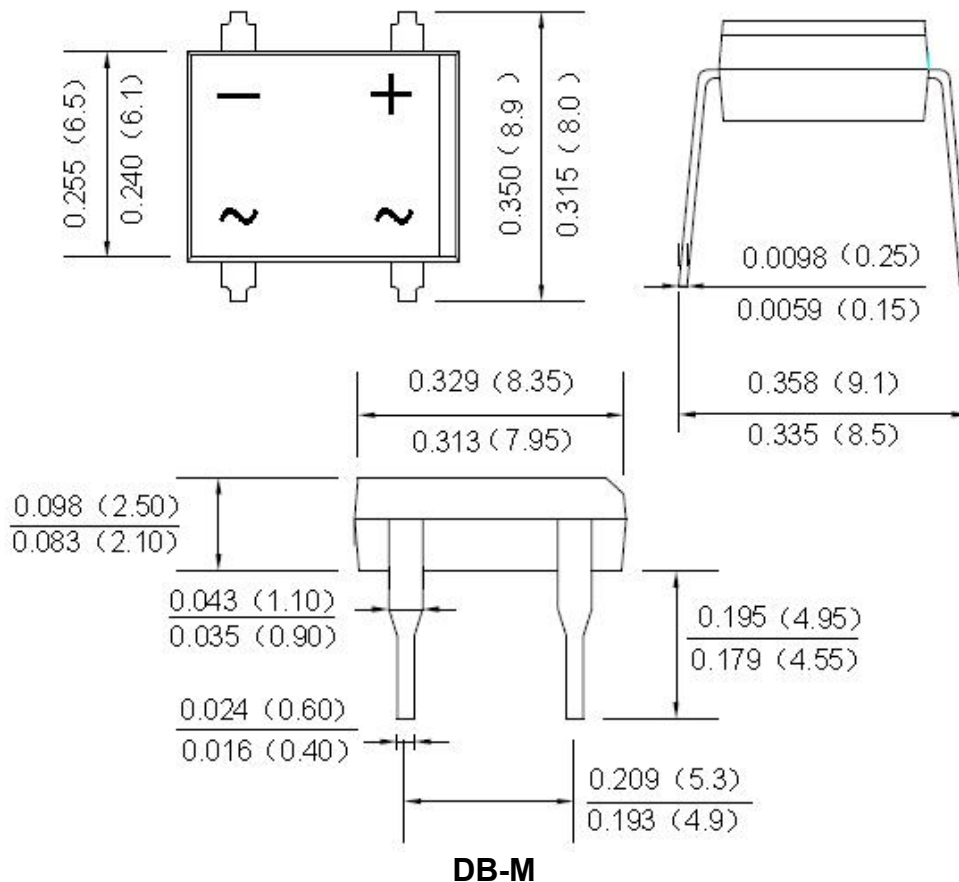
Features:

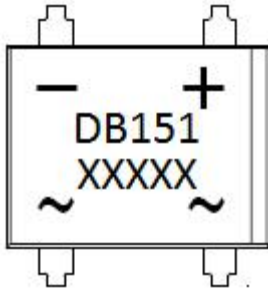
- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Plastic material-UL flammability 94V-0

Mechanical Data:

- Case: DB-M, Molded plastic
- Terminals: Plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting Position: Any
- Lead Free: For RoHS / Lead Free Version

Mechanical Dimensions: In Inches/mm



Technical Data
Data Sheet N1915, Rev. -
Marking Diagram:
Green Products


Where XXXXX is YYWWL

 DB151S = Part Name
 YY = Year
 WW = Week
 L = Lot Number

Cautions: Molding resin
 Epoxy resin UL: 94V-0

Maximum Ratings and Electrical Characteristics Rating at 25°C ambient temperature unless otherwise specified. Single Phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Type Number	Symbol	DB151	DB152	DB153	DB154	DB155	DB156	DB157	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_{DC}	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Average forward rectified output current (Note 1) @ $T_A = 40^\circ\text{C}$	I_o	1.5							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	55							A
Forward Voltage (per element) @ $I_F = 1.5\text{A}$	V_F	1.1							V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A = 125^\circ\text{C}$	I_{RM}	5.0 500							μA
Typical Junction Capacitance(per leg) (Note 2)	C_J	25							pF
Typical Thermal Resistance (per leg)	$R_{\theta JA}$ $R_{\theta JL}$	40 15							$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

 Note: 1. Mounted on glass epoxy PC board with 1.3mm² solder pad.
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

Fig. 1 Output Current Derating Curve

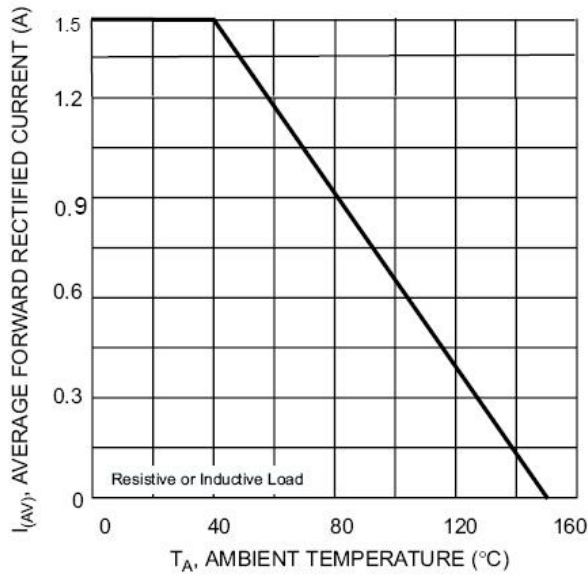


Fig. 2 Typical Forward Characteristics (per leg)

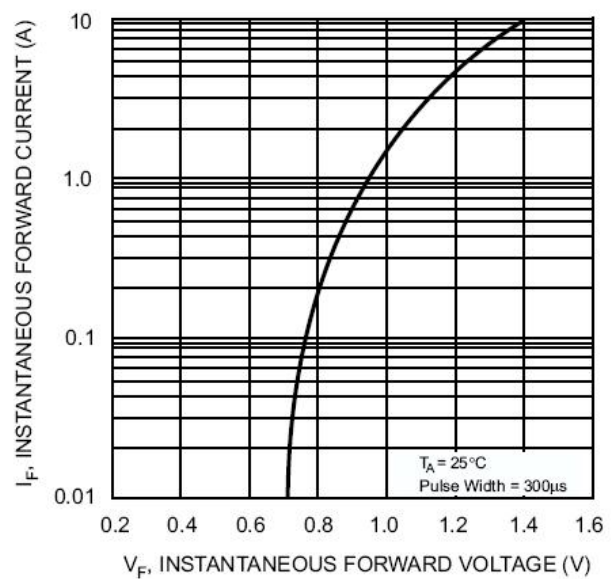


Fig. 3 Maximum Peak Forward Surge Current (per leg)

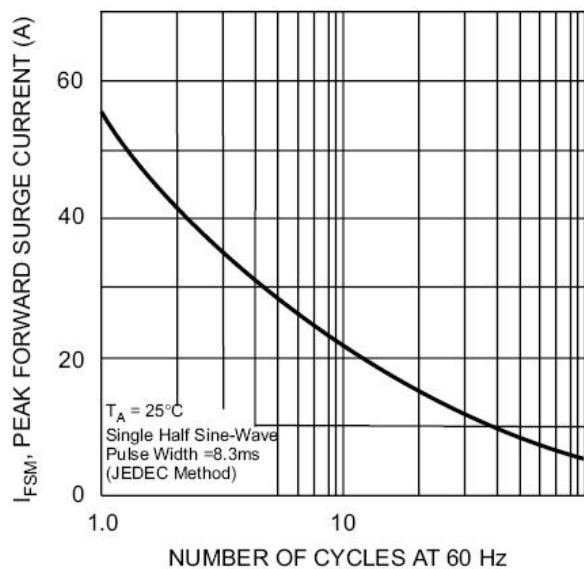
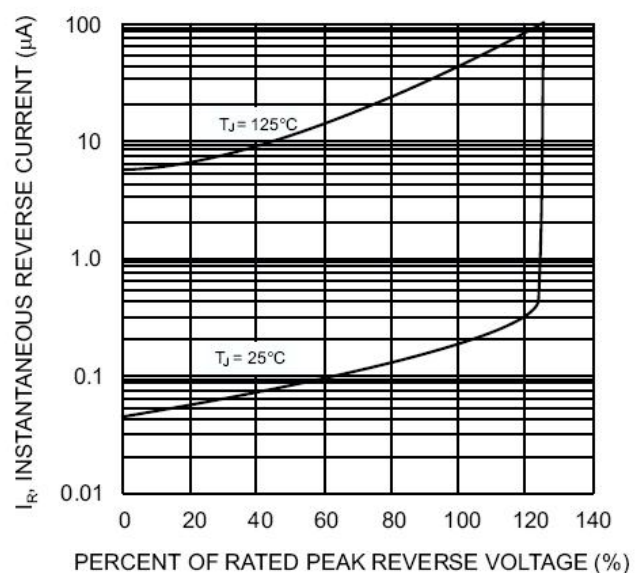


Fig. 4 Typical Reverse Characteristics (per element)



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